

# **High Power LED Driver IC**

#### **DESCRIPTION**

The AP7350Q is an instant On/Off LED drive IC for high flux LED and adjustable constant-current source, easily driving loads 50mA up to 1A through an external resistor. The SHDN of the AP7350Q permits LED brightness regulation by pulse width modulation (PWM). The LED brightness can be regulated via duty cycle. And if SHDN sets high, the AP7350Q will be in sleep mode. the SHDN pin also can be used as an enable input. This integration technology eliminates individual components by combining them into a small package, which results in a significant reduction of both system cost and board space.

#### **FEATURES**

- Dimming control or Sleep mode by MiCOM signal
- LED drive current adjustable through external resistor (Max 1A under PWM)
- Very Simple Circuit Design and Very low cost design
- Very small package of 4.5x4.35mm SOT89-5L
- Halogen-Free Package is Available

## **Applications**

- Backlighting LED Drive.
- High flux LED Drive
- Industrial Lamp Indicators
- Constant current source
- Automotive lighting

### **Pin Connection & Marking Information**



**SOT89-5** 



# **Ordering Information**

Part No	Package	Packing	Finish	Halogen	REEL unit	Remark
AP7350Q	SOT-89-5	Tape & Reel	Sn	Free	1,000	MOQ 10Kp

# **Maximum Ratings**

Characteristic	Symbol	Rating	Units
Power Supply Voltage	VCC(MAX)	25	v
Output Voltage	Vout(max)	25	V
Output Sink Current	IOUT(MAX)	1	Α
High Wattage Land Pattern Power Dissipation	<b>P</b> <sub>D</sub> <sup>1)</sup>	1.3	w
Standard Land Pattern Power Dissipation	<b>P</b> <sub>D</sub> <sup>2)</sup>	0.9	w
Thermal Resistance Junction-Ambient	<b>R</b> тн(J-A) <sup>1)</sup>	150	°C/W
Operating Temperature Range	Topr	-40 ~ 85	°C
Storage Temperature Range	Тѕтс	-55 ~ 125	°C

#### Note

## **Recommended operating conditions**

Charastaristis	Sumb al	Rat	lluit.		
Characteristic	Symbol	Min.	Max.	Units	
Power Supply Voltage	VCC(MAX)	3	24	V	
Output Voltage	Vout(MAX)	1.5	Vcc	٧	
Output Sink Current	IOUT(MAX)	-	1	Α	
Shut Down Voltage	SHDN	-0.3	Vcc	V	

<sup>1)</sup> Mounted on High Wattage Land Pattern Board (  $30mm \times 30mm \times 1.6mm$  ) ------ See Page 9

<sup>2)</sup> Mounted on Standard Land Pattern Board (  $50mm \times 50mm \times 1.6mm$  ) ------- See Page 9



## **Electrical Characteristics**

Test Conditions : Ta = 25°C, unless otherwise specified

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
IQ Maximum	IQ	Vcc = 3~24V, Iout = 20mA, Vout = open	-	18	24	mA
Leak Current	Ileak	Vcc = 5V, Vout = 24V	-	0.1	1	uA
Feedback Voltage	VFB	Vcc = 5V, Iout = 10mA	192	200	208	mV
Dropout Voltage	Vdrop	Vcc = 5V, Iout = 500mA	-	0.7	1.5	٧
Line Regulation	ΔVFB1	Vcc = 3~24V, Iout = 10mA	-	2	10	mV
Load Regulation	ΔVFB2	Vcc = 5V, Iout = 10mA, Vout = Vcc	-	3	25	mV
SHDN Voltage ON	Vdis on	Vcc = 5V, Iout = 10mA, Vout = Vcc	1.5	-	-	V
SHDN Voltage Off	Vdis off	Vcc = 5V, Iout = 10mA	-	-	0.5	٧
SHDN Pin Current	Idis	Vcc = 5V, SHDN = 5V	230	430	630	uA
Short Circuit Current	Isc	Rfb = 0Ω	-	1.9	-	Α
Thermal Shutdown	TTSD	-	-	160	-	°C

#### Notes

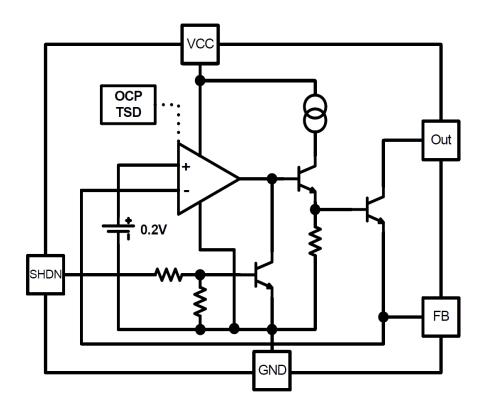
1. These parameters, although guaranteed, are not 100% tested in production.

## **Switching Characteristics**

Characteristic	Symbol	<b>Test Conditions</b>	Min.	Тур.	Max.	Units
Propagation Delay Time ("L" to "H")	tpLH	$V_{cc} = 3.5V$ $V_{SHDN}.H = 5V$	0.6	1	-	μs
Propagation Delay Time ("H" to "L")	tpHL	$V_{SHDN}.L = GND$ RFB = $0.2\Omega$	0.2	1	-	μs
Pulse width	tw	(IOUT = 1A) $ROUT = 2Ω$	1			μs
Output Rise Time (turn off)	tr	CL = 10pF	0.5	1	-	μs
Output Fall Time (turn on)	tf		0.1	0.2	-	μs



## **Internal Block Diagram**

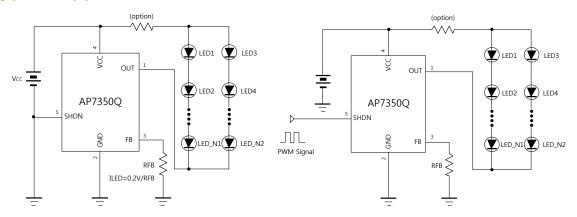


# **Design Consideration**

- 1) Calculation for RFB
- RFB = 0.2V / ILED
- 2) Calculation for Vdrop
- Vdrop = VCC VLED
- 3) Calculation for Power Dissipation on the AP7350Q
- $-PD1 = (Vdrop VFB) \times ILED$
- $-PD2 = VCC \times IQ$
- -PD(total) = PD1 + PD2
- 4) If does not use an Dimming function, connect SHDN Pin with the ground.



## **Typical Applications**

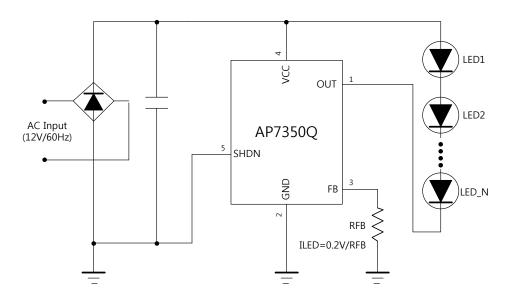


<APP1. Constant Current LED Driver Circuit>

<APP2. PWM Dimming LED Driver Circuit>

#### **X** Caution

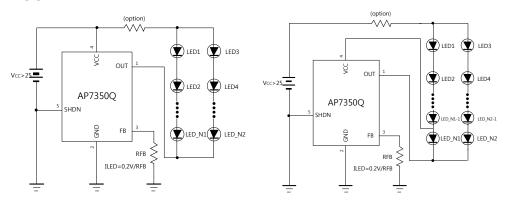
In the case of high current application, we recommend to control the PWM using by  $\overline{SHDN}$ . If user cannot uses the PWM control, the application must be limited in  $P_D(=V_{DROP}\times I_{LED})$ . So, in this case we recommend to minimize  $V_{DROP}$  or  $I_{LED}$ . (See page 9)



<APP3. Vac Landscape Lightning Application Circuit>



## **Typical Applications**

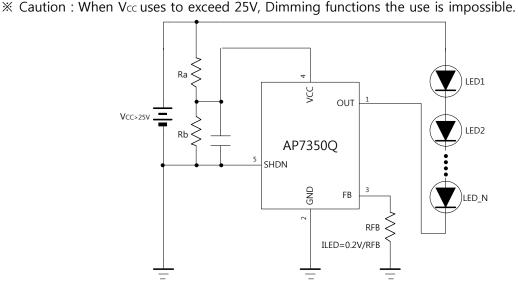


<APP4. High Voltage Operation of AP7305Q (1)>

<APP5. High Voltage Operation of AP7305Q (2)>

For operation in excess of AP7350Q specified maximum voltage (Vcc & Vout) of 25V, one way is to connect a sufficient number of LEDs between the power supply voltage and the DC input of the Vcc&Vout such that the voltage seen at pin(Vcc & Vout) is less than 25V. That is to say, use additional LEDs to drop the voltage fed to the AP7350Q below its maximum rating, in the usual way. Refer to **APP4,5** Note that the exact number of diodes required will depend on the supply voltage Vcc and output voltage Vout, the voltage drops across the particular LEDs being used. (Red, Blue and White LEDs have different forward voltage drop.)

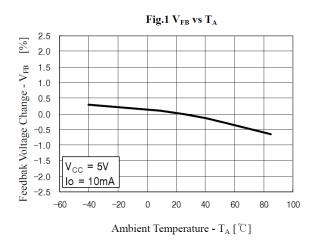
Use enough LEDs such that voltage at pin(Vcc & Vout) of AP7350Q is < 25V.

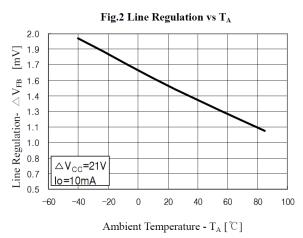


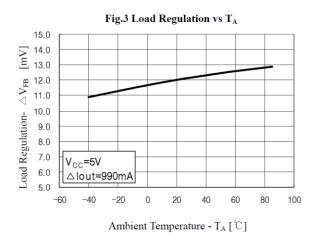
<APP6. Power Supply Where Separates Operation of AP7350Q>

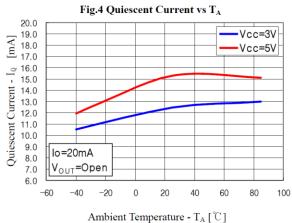


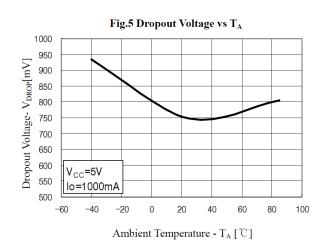
### **Electrical Characteristic Curves**

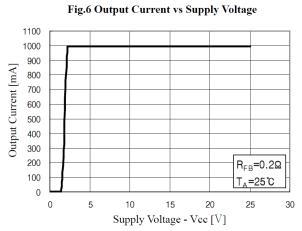






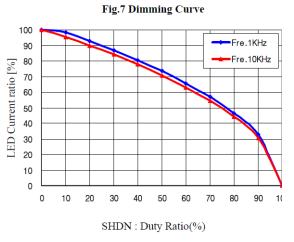








### **Electrical Characteristic Curves**



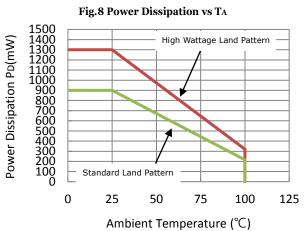


Fig.9 Dimming Waveform [1kHz]

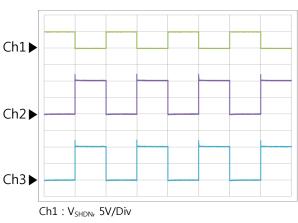
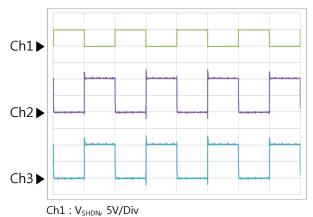


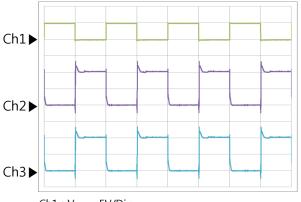


Fig.10 Dimming Waveform [10kHz]



Ch2:  $V_{FB}$ , 100mV/Div Ch3:  $I_{FB}$ , 5mA/Div

Fig.11 Dimming Waveform [50kHz]

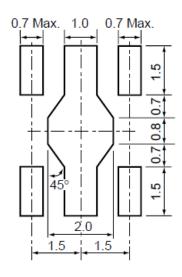


Ch1 :  $V_{SHDN}$ , 5V/Div Ch2 :  $V_{FB}$ , 100mV/Div Ch3 :  $I_{FB}$ , 5mA/Div



## **Recommend PCB solder land**

Unit: mm



## **Power Dissipation**

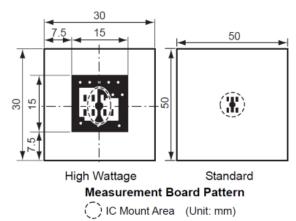
#### <Table 1. PCB Condition>

	High Wattage Land Pattern	Standard Land Pattern
Environment	Mounting on Board (Wind velocity = 0m/s)	Mounting on Board (Wind velocity = 0m/s)
Board Material	Glass cloth epoxy plastic (Double sided)	Glass cloth epoxy plastic (Double sided)
Board Dimension	30mm × 30mm × 1.6mm	50mm × 50mm × 1.6mm
Copper Ratio	Top side : Approx. 20% ,	Top side : Approx. 10%,
	Back side : Approx. 100%	Back side : Approx. 100%
Through-holes	Ф0.85mm × 10pcs	-

### <Table 2. Power Dissipation of Land Patterns>

	High Wattage Land Pattern	Standard Land Pattern
Power Dissipation	1300mW	900mW
Thermal Resistance	77°C/W	111℃/W

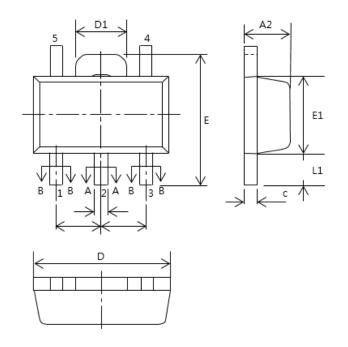
(Topt=25°C,Tjmax=125°C)





# **Package Dimension**

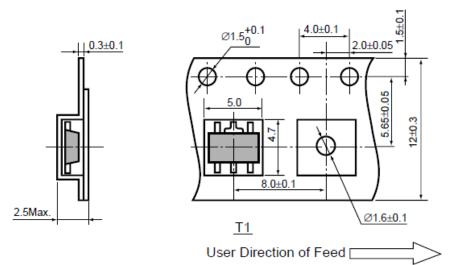
### Unit: mm



SOT-89-5L unit : mm				
DIM	MIN NOM MAX			
A2	1.40	1.50	1.60	
D	4.30	4.50	4.70	
D1	1.83REF			
E	3.95 - 4.25			
E1	2.30	2.50	2.70	
е	1.50BSC			
L1	0.89	-	1.20	

## **Taping Specification**

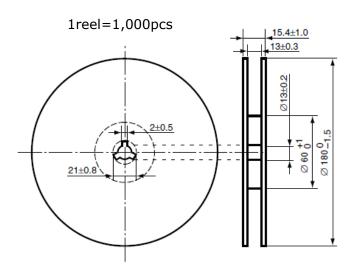
### Unit: mm





# **Reel Specification**

### Unit: mm





### **Revision History**

No	Date	Contents
00	2015-12-30	Initial Brief Datasheet Release
01	2016-04-01	Addition switching characteristics

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#### **IMPORTANT NOTICE**

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